PRODUCT ADVISORY

Data Sheet Specification Change for Intersil Product ISL28191* and ISL28291*

Refer to: PA14045

Date: July 22, 2014



July 22, 2014

To: Our Valued Intersil Customers

Subject: Data Sheet Specification Change for Intersil Product ISL28191* and ISL28291*

This advisory is to inform you that Intersil has updated the data sheet specification for the ISL28191* and ISL28291* products. The change is to the θ_{JA} value in the Thermal Information section to align the data sheet with the product characteristics. Details regarding the change are contained on the following page. The updated data sheet is available is available on the Intersil web site at:

http://www.intersil.com/content/dam/Intersil/documents/fn61/fn6156.pdf.

Products affected:

There have been no changes to the die/silicon or product itself. There will be no change in the external marking of the packaged parts.

Intersil will take all necessary actions to conform to agreed upon customer requirements and to ensure the continued high quality and reliability of Intersil products being supplied. Customers may expect to continue receiving product processed to the same established conditions and systems used for manufacturing of material supplied today.

If you have concerns with this advisory, Intersil must hear from you promptly. Please contact the nearest Intersil Sales Office or call the Intersil Corporate line at 1-888-468-3774, in the United States, or 1-321-724-7143 outside of the United States.

Regards,

Intersil Corporation

Jeffrey Touvell

PA14045

CC: D. LaFontaine J. Bailey P. Lee

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PA14045 Data Sheet Change

From:

Absolute Maximum Ratings (T_A = +25°C)

Supply Voltage
Supply Turn On Voltage Slew Rate
Differential Input Current 5mA
Differential Input Voltage0.5V
Input Voltage V 0.5V to V+ + 0.5V
ESD Tolerance
Human Body Model
Machine Model
Charged Device Model (CDM)1200V

Thermal Information

Thermal Resistance (Typical, Note 6)	θ _{JA} (°C/W)
6 Ld SOT-23 Package	230
6 Ld UTDFN Package	125
8 Ld SOIC Package	110
10 Ld MSOP Package	150
10 Ld UTQFN Package	143
Storage Temperature Range65	s°C to +150°C
Pb-Free Reflow Profile	see link below
http://www.intersil.com/pbfree/Pb-FreeReflow.asp	

To:

Absolute Maximum Ratings $(T_A = +25 \circ C)$

Supply Voltage	5.5V
Supply Turn On Voltage Slew Rate	V/µs
Differential Input Current	5mA
Differential Input Voltage	0.5V
Input Voltage V 0.5V to V+ +	0.5V
ESD Tolerance	
Human Body Model	3kV
Machine Model	300V
Charged Device Model (CDM)	200V

Thermal Information

Thermal Resistance (Typical)	$\theta_{I\Delta}$ (°C/W)	$\theta_{IC}(^{\circ}C/W)$		
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6 Ld SOT-23 Package (Notes 6, 9)	170	105		
6 Ld UTDFN Package (Notes 7, 8)	125	80		
8 Ld SOIC Package (Notes 6, 9)	110	82		
10 Ld MSOP Package (Notes 6, 9)	175	90		
10 Ld UTQFN Package (Notes 6, 9)	190	140		
Storage Temperature Range65°C to +150°C				
Pb-Free Reflow Profile see link below				
http://www.intersil.com/pbfree/Pb-FreeReflow.asp				

Note: Changes are shaded in yellow